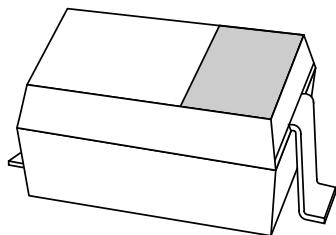


DATA SHEET



BAS316

High-speed diode

Product specification
Supersedes data of 1998 Mar 26

2004 Feb 04

High-speed diode**BAS316****FEATURES**

- Very small plastic SMD package
- High switching speed: max. 4 ns
- Continuous reverse voltage: max. 100 V
- Repetitive peak reverse voltage: max. 100 V
- Repetitive peak forward current: max. 500 mA.

APPLICATIONS

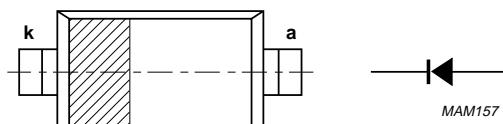
- High-speed switching in e.g. surface mounted circuits.

DESCRIPTION

The BAS316 is a high-speed switching diode fabricated in planar technology, and encapsulated in the SOD323 SMD plastic package.

PINNING

PIN	DESCRIPTION
1	cathode
2	anode



Marking code: A6.
Cathode side indicated by a bar.

Fig.1 Simplified outline (SOD323) and symbol.

ORDERING INFORMATION

TYPE NUMBER	PACKAGE			VERSION
	NAME	DESCRIPTION	VERSION	
BAS316	–	plastic surface mounted package; 2 leads		SOD323

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{RRM}	repetitive peak reverse voltage		–	100	V
V_R	continuous reverse voltage		–	100	V
I_F	continuous forward current	$T_s = 90^\circ\text{C}$; note 1; see Fig.2	–	250	mA
I_{FRM}	repetitive peak forward current		–	500	mA
I_{FSM}	non-repetitive peak forward current	square wave; $T_j = 25^\circ\text{C}$ prior to surge; see Fig.4 $t = 1 \mu\text{s}$ $t = 1 \text{ ms}$ $t = 1 \text{ s}$	– – –	4 1 0.5	A A A
P_{tot}	total power dissipation	$T_s = 90^\circ\text{C}$; note 1	–	400	mW
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature		–	150	°C

Note

1. T_s is the temperature at the soldering point of the cathode tab.

High-speed diode

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CHARACTERISTICS

 $T_j = 25^\circ\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
V_F	forward voltage	see Fig.3 $I_F = 1 \text{ mA}$ $I_F = 10 \text{ mA}$ $I_F = 50 \text{ mA}$ $I_F = 150 \text{ mA}$	715 855 1 1.25	mV mV V V
I_R	reverse current	see Fig.5 $V_R = 25 \text{ V}$ $V_R = 75 \text{ V}$ $V_R = 25 \text{ V}; T_j = 150^\circ\text{C}$ $V_R = 75 \text{ V}; T_j = 150^\circ\text{C}$	30 1 30 50	nA μA μA μA
C_d	diode capacitance	$f = 1 \text{ MHz}; V_R = 0$; see Fig.6	1.5	pF
t_{rr}	reverse recovery time	when switched from $I_F = 10 \text{ mA}$ to $I_R = 10 \text{ mA}$; $R_L = 100 \Omega$; measured at $I_R = 1 \text{ mA}$; see Fig.7	4	ns
V_{fr}	forward recovery voltage	when switched from $I_F = 10 \text{ mA}$; $t_r = 20 \text{ ns}$; see Fig.8	1.75	V

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th(j-s)}$	thermal resistance from junction to soldering point	note 1	150	K/W

Note

1. Soldering point of the cathode tab.

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GRAPHICAL DATA

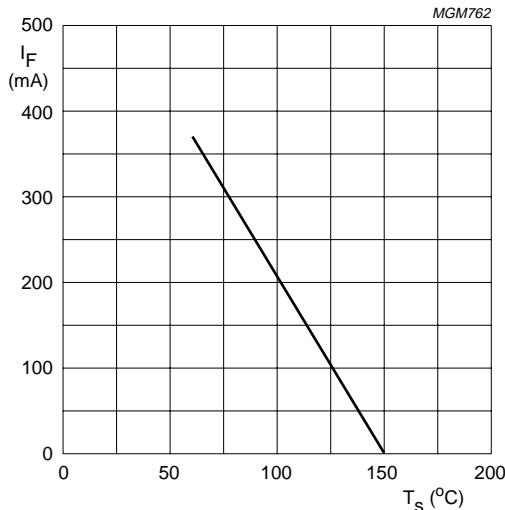
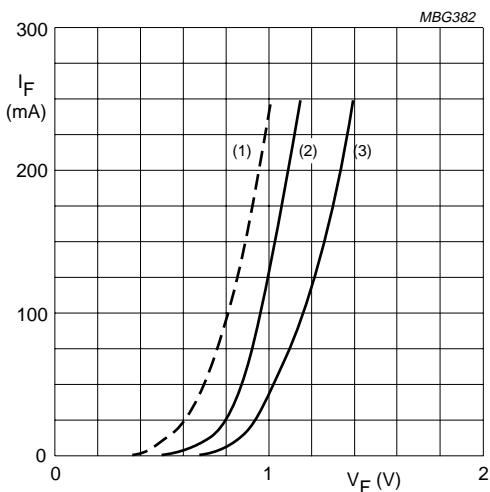
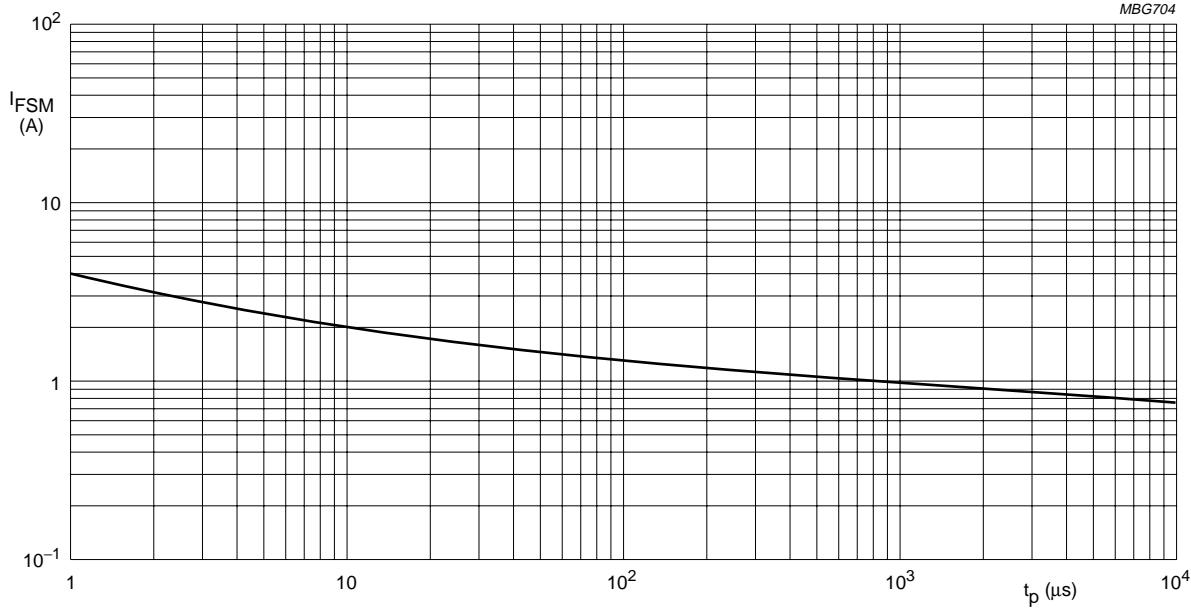


Fig.2 Maximum permissible continuous forward current as a function of soldering point temperature.



- (1) $T_j = 150$ $^{\circ}$ C; typical values.
- (2) $T_j = 25$ $^{\circ}$ C; typical values.
- (3) $T_j = 25$ $^{\circ}$ C; maximum values.

Fig.3 Forward current as a function of forward voltage.



Based on square wave currents.
 $T_j = 25$ $^{\circ}$ C prior to surge.

Fig.4 Maximum permissible non-repetitive peak forward current as a function of pulse duration.

High-speed diode

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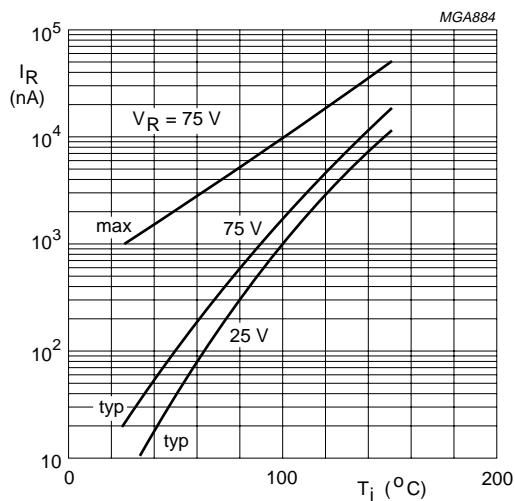
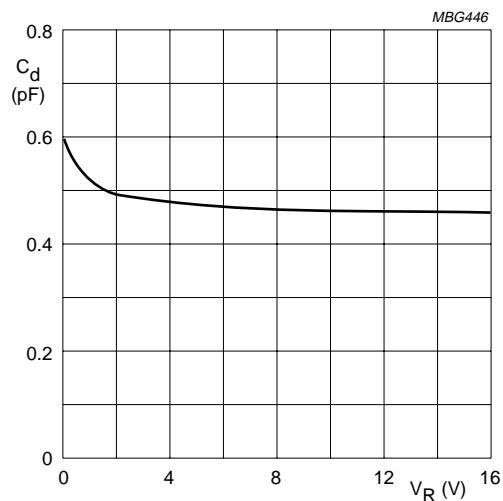


Fig.5 Reverse current as a function of junction temperature.

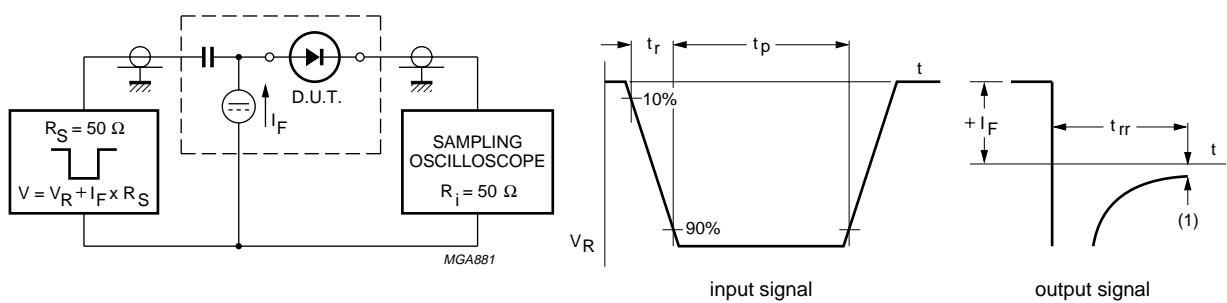


$f = 1\text{ MHz}; T_j = 25\text{ }^{\circ}\text{C}.$

Fig.6 Diode capacitance as a function of reverse voltage; typical values.

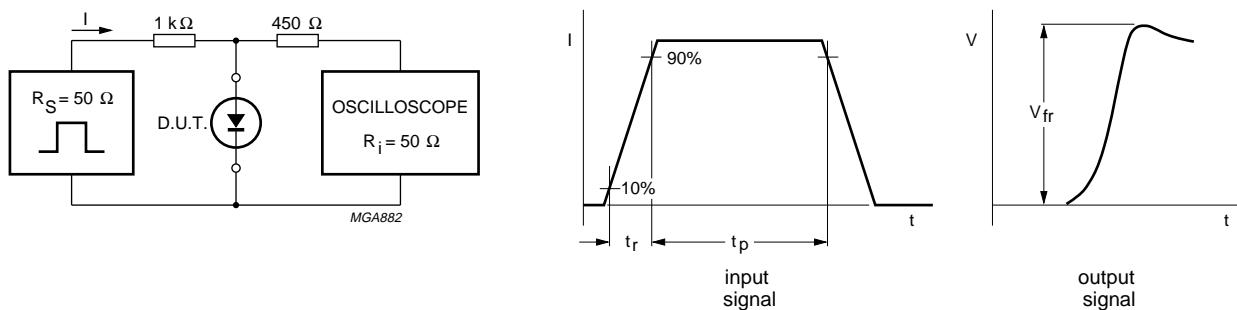
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(1) $I_R = 1$ mA.

Input signal: reverse pulse rise time $t_r = 0.6$ ns; reverse voltage pulse duration $t_p = 100$ ns; duty factor $\delta = 0.05$;
Oscilloscope: rise time $t_r = 0.35$ ns.

Fig.7 Reverse recovery voltage test circuit and waveforms.



Input signal: forward pulse rise time $t_r = 20$ ns; forward current pulse duration $t_p \geq 100$ ns; duty factor $\delta \leq 0.005$.

Fig.8 Forward recovery voltage test circuit and waveforms.

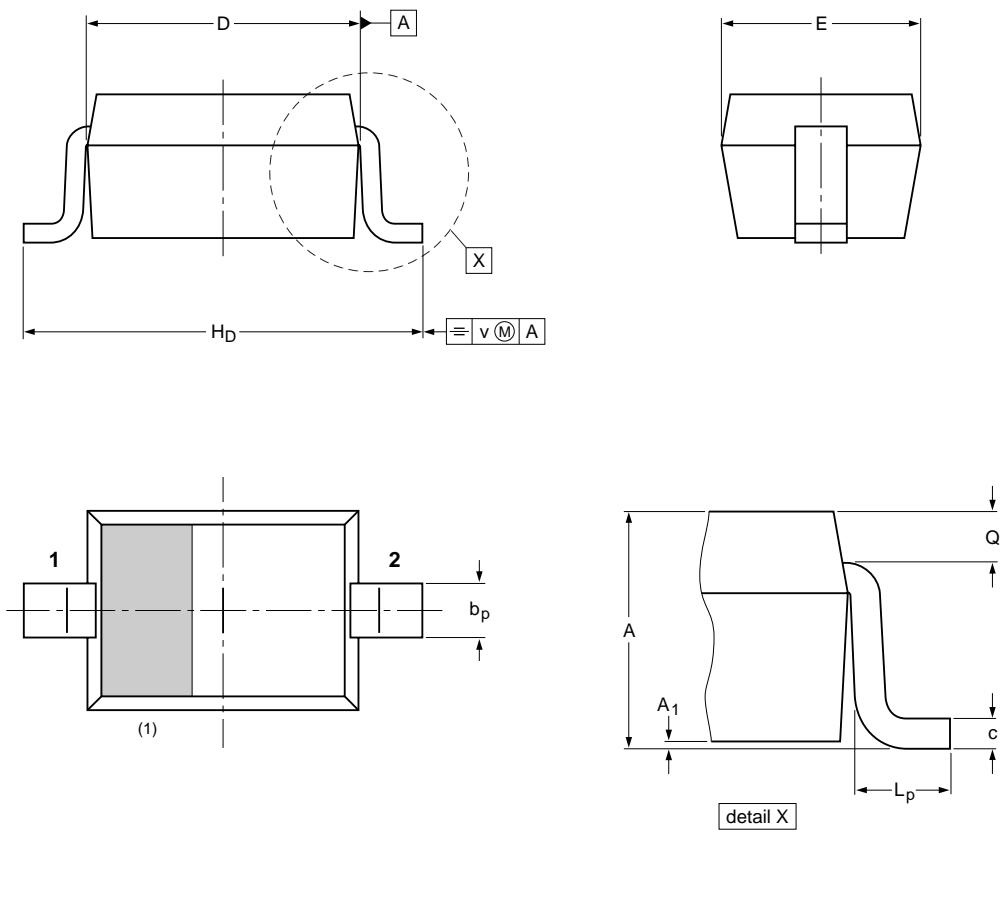
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PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD323



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max	b _p	c	D	E	H _D	L _p	Q	v
mm	1.1 0.8	0.05	0.40 0.25	0.25 0.10	1.8 1.6	1.35 1.15	2.7 2.3	0.45 0.15	0.25 0.15	0.2

Note

1. The marking bar indicates the cathode

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA	SC-76		
SOD323						-99-09-13- 03-12-17

High-speed diode

BAS316

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

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3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device.

These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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